



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Connell et al.

Serial No.: 10/082,372

Filed: February 25, 2002

For: WAFER BACK SIDE COATING TO
BALANCE STRESS FROM PASSIVATION
LAYER ON FRONT OF WAFER AND BE
USED AS A DIE ATTACH ADHESIVE

Confirmation No.: 1935

Examiner: A. Stevenson

Group Art Unit: 2812

Attorney Docket No.: 2269-5083US
(01-0428.00/US)

Notice of Allowance Mailed:

June 29, 2005

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

September 21, 2005
Date

Leta M. Howard
Signature

Leta M. Howard
Name (Type/Print)

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Abstract appear on page 12 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 13 of this paper.

Remarks begin on page 26 of this paper.